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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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NPN Built-in Resistor Transistor MPAK Series Inverter, Driver, Switching



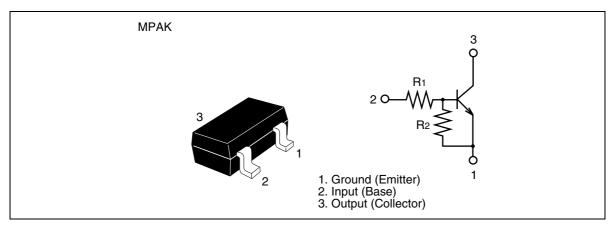
ADE-208-1443B (Z)

Rev.2 Sep. 2001

#### **Features**

- Built-in Resistor Type
- Simplifies Circuit Design
- Reduces Board Space
- Complementary pair with BRA144EMP series

#### **Outline**



Note: Marking is shown in below.

Device	Marking	R1 (kΩ)	R2 (kΩ)
BRC144EMP	BG	47	47
BRC124EMP	DG	22	22
BRC114EMP	FG	10	10
BRC143EMP	HG	4.7	4.7
BRC123EMP	KG	2.2	2.2

## **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

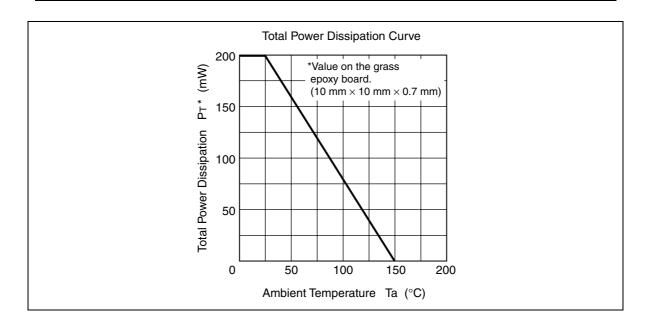
Item		Symbol	Ratings	Unit	
Supply voltage		V <sub>cc</sub>	50	V	
Input voltage	BRC144EMP	V,	-10 to +40	V	
	BRC124EMP		-10 to +30	<del></del>	
	BRC114EMP		-10 to +20	<del></del>	
	BRC143EMP		-10 to +15	<del></del>	
	BRC123EMP		-10 to +12		
Output current		I <sub>o</sub>	100	mA	
Total power dissipation		P <sub>T</sub> *1	200	mW	
Junction temperature		Tj	150	°C	
Storage temperature		Tstg	-55 to +150	°C	_

<sup>\*</sup>Value on the glass epoxy board. (10 mm  $\times$  10 mm  $\times$  0.7 mm)

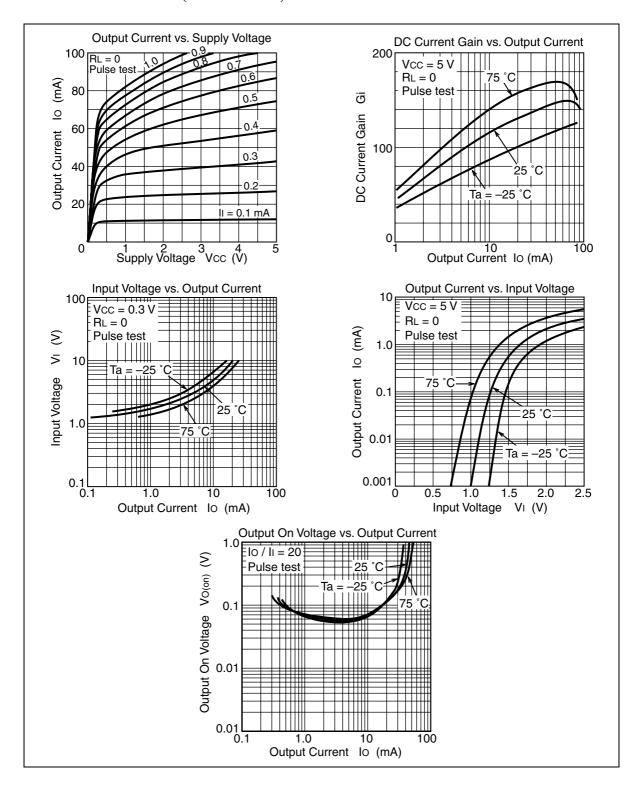
### **Electrical Characteristics**

 $(Ta = 25^{\circ}C)$ 

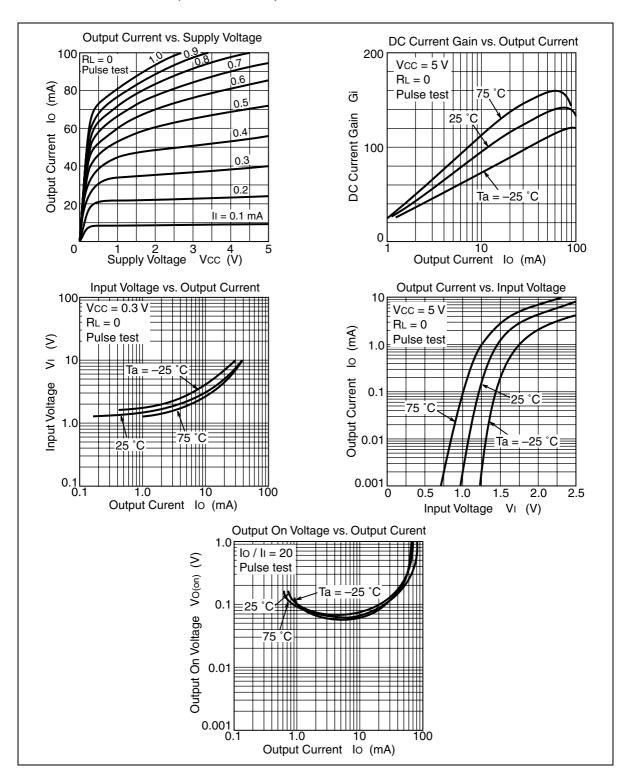
Item		Symbol	Min	Тур	Max	Unit	Test conditions
Input on voltage	BRC144EMP	V <sub>I(on)</sub>	1.5	_	4.5	V	$V_{cc} = 0.3 \text{ V}, I_{o} = 5 \text{ mA}$
	BRC124EMP	_	1.3	_	3.0		
	BRC114EMP	_	1.2	_	2.4		
	BRC143EMP	_	1.1	_	2.0		
	BRC123EMP	_	1.1	_	1.8		
Input off voltage	BRC144EMP	V <sub>I(off)</sub>	1.0	_	1.5	V	$V_{cc} = 5 \text{ V}, I_{o} = 100 \mu\text{A}$
	BRC124EMP	_	1.0	_	1.5		
	BRC114EMP	_	1.0	_	1.5		
	BRC143EMP	_	1.0	_	1.5		
	BRC123EMP	_	1.0	_	1.5		
Output saturation voltage		$V_{_{O(on)}}$	_	_	0.3	V	$I_0 = 10 \text{ mA}, I_1 = 0.5 \text{ mA}$
Output cutoff current		I <sub>O(off)</sub>	_	_	0.5	μΑ	$V_{cc} = 50 \text{ V}, I_{i} = 0$
DC current transfer ratio	BRC144EMP	Gi	70	_	_		$V_{cc} = 5 \text{ V}, I_{o} = 5 \text{ mA}$
	BRC124EMP	- -	56	_	_	_	
	BRC114EMP		30	_	_		
	BRC143EMP		20	_	_		$V_{cc} = 5 \text{ V}, I_{o} = 10 \text{ mA}$
	BRC123EMP	_	20	_	_		$V_{cc} = 5 \text{ V}, I_{o} = 20 \text{ mA}$
Input resistance	BRC144EMP	R <sub>1</sub>	33	47	61	kΩ	
	BRC124EMP	_	15	22	28		
	BRC114EMP	_	7	10	13		
	BRC143EMP	_	3.3	4.7	6.1		
	BRC123EMP	_	1.5	2.2	2.8		
Resistance ratio		R <sub>1</sub> /R <sub>2</sub>	0.8	1.0	1.2		



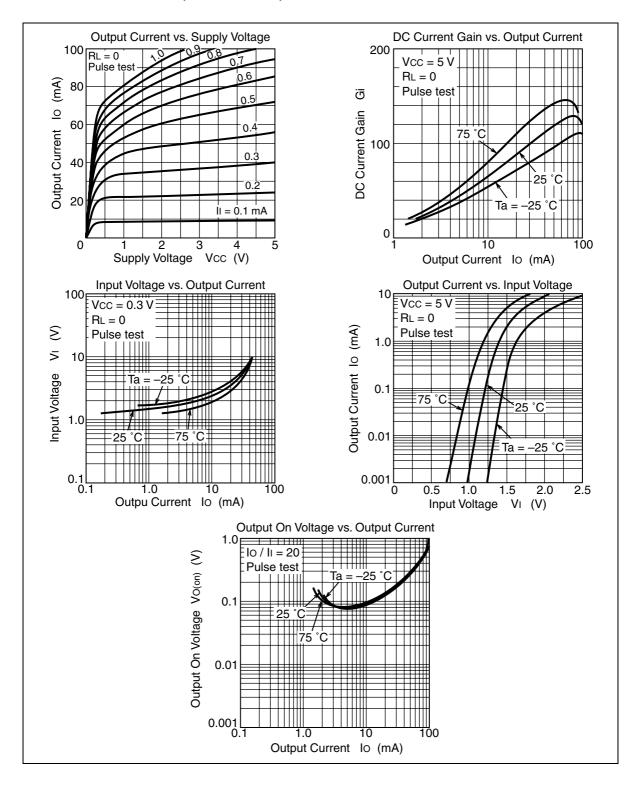
#### **Main Characteristics (BRC144EMP)**



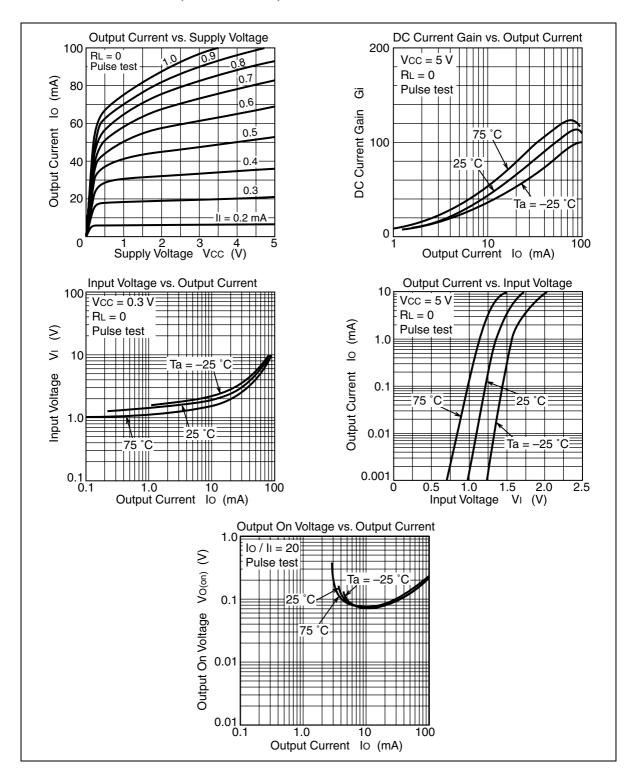
#### **Main Characteristics (BRC124EMP)**



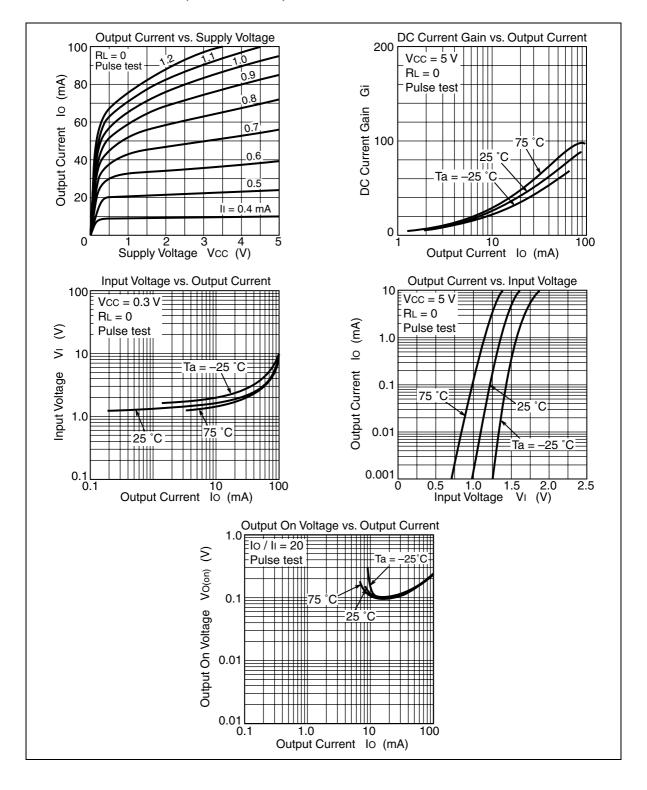
#### **Main Characteristics (BRC114EMP)**



#### **Main Characteristics (BRC143EMP)**



#### **Main Characteristics (BRC123EMP)**



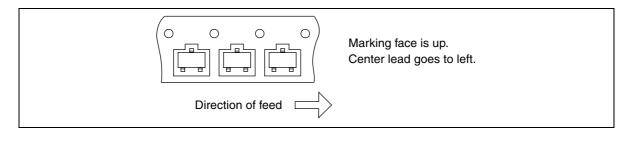
### **Taping Specification**

There are two different size reels in MPAK packaging.

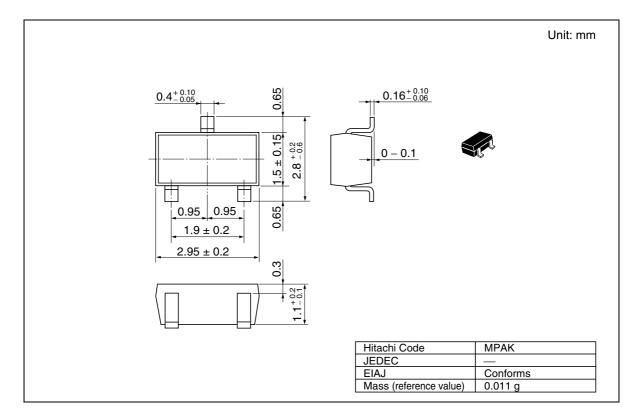
Packing to "Left" direction

Purchasing Identification Code

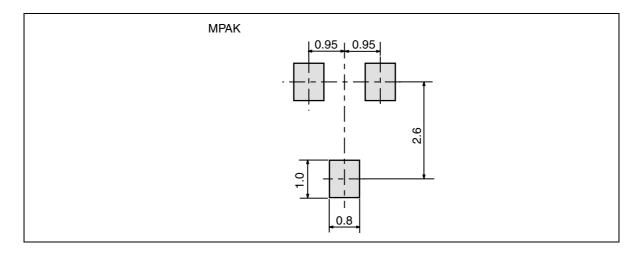
Standard Reel 3000 pcs/reel: Type No. + Mark TL Large Reel 12000 pcs/reel: Type No. + Mark UL



### **Package Dimensions**



### **Footprint**



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